# Leaded common mode choke coil for Consumer equipment & Industrial equipment PLT10HN DDDD REFERENCE SPECIFICATION

#### 1. Scope

This reference specification applies to Leaded common mode choke coil PLT10HN Series.

#### 1.1 Specific applications:

- Power equipment: Products that can be used in power equipment such as renewable energy equipment, energy storage
  equipment and EV charging equipment and whose functions are not directly related to the protection of human life and
  property.
- Industrial equipment: Products that can be used in industrial equipment such as base stations, manufacturing equipment, industrial robotics equipment, and measurement equipment, and whose functions do not directly relate to the protection of human life and property.
- Medical equipment (GHTF Class C) \*Except for implant/surgery/auto injector: Products that can be used for medical
  equipment of Class C of the international classification class GHTF and whose malfunction is considered to pose a relatively
  high risk to the human body.
- Medical equipment (GHTF Class A and B): Products that can be used for medical equipment regulated by Class A and Class B of the international classification class GHTF and whose functions do not directly relate to the protection of human life and property.
- Consumer equipment: Products that can be used in consumer equipment such as home appliances, audio/visual equipment, communication equipment, information equipment, office equipment, and household robotics, and whose functions are not directly related to the protection of human life and property.

#### 1.2 Unsuitable application:

Applications listed in "Limitation of applications" in this reference specification.

WE DISCLAIM ANY LOSS AND DAMAGES ARISING FROM OR IN CONNECTION WITH THE PRODUCTS INCLUDING BUT NOT LIMITED TO THE CASE SUCH LOSS AND DAMAGES CAUSED BY THE UNEXPECTED ACCIDENT, IN EVENT THAT THE PRODUCT IS APPLIED FOR THE PURPOSE WHICH IS SPECIFIED ABOVE AS THE UNSUITABLE APPLICATION FOR THE PRODUCT.

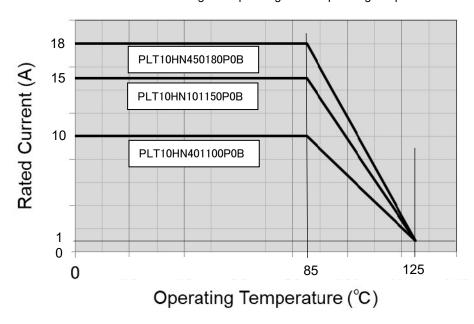
2. Part Numbe	ring						
(Ex.) <u>PLT</u>	<u>10H</u>	<u>N</u>	401	100	<u>P</u>	0	<u>B</u>
Product ID	Type	Application	Common Mode	Rated	Winding	Dimenssion	n Packaging
			Impedance Zc	Current	Mode		code
3. Rating							

Customer Part Number	MURATA Part Number	Common Mode Impedance Zc (at10MHz) Typ.	Rated Voltage	Withstand Voltage	* Rated Current	DC Resistance (Rdc)	Insulation Resistance (I.R.)	Inductance (L)
	PLT10HN401100P0B	400Ω	100V (DC)	250V (DC)	10A	$3.6 m\Omega$ $\pm 0.5 m\Omega$	10MΩ min.	6μH min.
	PLT10HN101150P0B	100Ω	300V (DC)	750V (DC)	15A	$1.8$ m $\Omega$ $\pm 0.5$ m $\Omega$	10MΩ min.	2.0µH min.
	PLT10HN450180P0B	45Ω	300V (DC)	750V (DC)	18A	$1.3$ m $\Omega$ $\pm 0.5$ m $\Omega$	10MΩ min.	0.8µH min.

<sup>·</sup> Operating Temperature range (Product temperature; Self- temperature rise is included) : -55°C∼+125°C

Storage Temperature range : -55°C~+125°C

\* Rated Current is derated as below figure depending on the operating temperature.

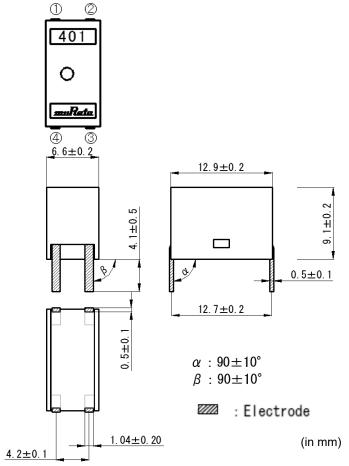


#### 4. Standard Testing Conditions

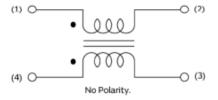
< Unless otherwise specified > Temperature: Ordinary Temp.15 °C to 35 °C Humidity: Ordinary Humidity 25 %(RH) to 85 %(RH) < In case of doubt >
Temperature: 20 °C ± 2 °C
Humidity: 60 %(RH) to 70 %(RH)

Atmospheric pressure: 86 kPa to 106 kPa

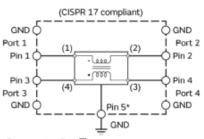
#### 5. Dimension



#### **■**Equivalent Circuit (Note1)



Note1: The Port/Pin No. of the Simulation Model provided by our company is as follows.

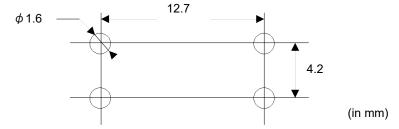


S-parameter: Port ☐ SPICE model: Pin ☐ (Pin5\* connect to GND)

#### ■Unit Mass (Typical value)

2.1g

#### ■Terminal Layout (Bottom Figure)

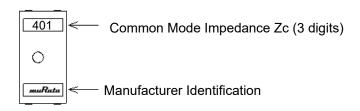


#### 6. Marking

(1)Manufacturer Identification : ( **muRata** )

(2)Parts Number: Common Mode Impedance Zc

PLT10HN401100P0B : ( **401** ) PLT10HN101150P0B : ( **101** ) PLT10HN450180P0B : ( **450** )



#### 7. Electrical Performance

No.	Item	Specification	Test method		
7.1	Common Mode Impedance (Zc) Typ.	Meet item 3	Measuring Frequency: 10MHz (ref.item Measuring Equipment: KEYSIGHT 4294A or the equ Use a cable / connector of $50\Omega$ impedance.	,	
7.2	Withstand Voltage	Products shall not be damaged.	Voltage: Rated Voltage×250% (ref.it Time:1∼5s Measuring current: 10mA max.	em 10)	
7.3	Insulation Resistance (I.R.)	Meet item 3	Voltage: Rated Voltage (ref.i Time: 30s max. Measuring current: 10mA max Measuring Equipment: KEYSIGHT 4339A or the equ	tem 10) ivalent	
7.4	DC Resistance (Rdc)	Meet item 3	Measuring method: four-terminal method (ref.it	em 10)	
7.5	Inductance (L)	Meet item 3	Measuring Frequency:1±0.1kHz (ref.ii Voltage: 1V (rms) max. Measuring Equipment: KEYSIGHT 4284A or the equ	tem 10) ivalent	

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#### 8. Mechanical performance

Νo.	Item	Specification		Test Method
8.1	Appearance and Dimensions			Visual Inspection and measured with Slide Calipers.
8.2	Marking	Marking is able (ref.item 5)	to be read.	Visual Inspection
8.3	Solderability	The electrodes shall be at least 90% covered with new solder coating.		Flux: Ethanol solution of rosin,25(wt)% Solder: Sn-3.0Ag-0.5Cu Pre-heating: 150°C±10°C, 60s Solder Temperature: 245°C±5°C Immersion Time: 3s±1s
8.4	Resistance	Table 1		Solder : Sn-3.0Ag-0.5Cu
	to soldering heat	Inductance	No damage	Pre-heating: 150°C~180°C, 90s±30s Peak: 270°C±5°C, 10s Reflow times: 1 time
8.5	(Reflow) Vibration	change (%ΔL)	within ±15%	It shall be soldered on the substrate.
		Insulation Resistance (I.R.)	Meet item 3	Oscillation Frequency: 10Hz to 2000Hz to 10Hz for 20 min Total Amplitude: 3.0mm or Acceleration amplitude
		Withstand Voltage	Products shall not be damaged.	196 m / s² whichever is smaller. Testing Time: A period of 4 hours in each of 3 mutually perpendicular directions. (Total 12 h)

#### 9. Environmental Performance

It shall be soldered on the substrate.

No.	item	specification		test method
9.1	heat shock	Meet Table 2 Table 2		1 cycle: 1 step: -55 °C(+0 °C,-3 °C) / 30min(+3min,-0min) 2 step: 125 °C (+3°C,-0 °C) / 30min(+3min,-0min)
		Appearance Inductance change	No damage Within ±20%	Total of 100 cycles  Then measured after exposure in the room condition for 48h± 4h.
9.2	Humidity life	(% Δ L) Insulation Resistance (I.R.) Withstand	Meet item 3 Products shall	Temperature: 85°C±2°C Humidity: 80~85%(RH) Voltage: Rated Voltage Time: 1000+48/-0 h Then measured after exposure in the room condition
0.0	l la at life	Voltage	not be damaged.	for 48±4 h
9.3	Heat life			125°C ±2 °C Voltage: Rated Voltage×200% Time: 1000+48/-0h Then measured after exposure in the room condition for 48±4 h

#### 10. Measuring Terminal

(When measuring and suppling the voltage, the following terminal is applied.)

No.	Item	Measuring terminal
10.1	Inductance (L) DC Resistance (Rdc)	INOOUT
10.2	Withstand voltage Insulation Resistance (I.R.) Humidity life Heat life	I N OUTO
10.3	Common Mode Impedance(Zc)	INOOUT



#### 11. Measuring method for common mode impedance.

Measured common mode impedance may be included measurement error due to stray capacitance, residual inductance of test fixture.

To correct this error, the common mode impedance should be calculate as follows;

- (1) Measure admittance of the fixture(opened), Go Bo.
- (2) Measure impedance of the fixture(shorted), Rs Xs.
- (3) Measure admittance of the specimen, Gm Bm.
- (4) Calculate corrected impedance | Z | using the formula below.

$$|Z| = (Rx^2 + Xx^2)^{1/2}$$
 Where

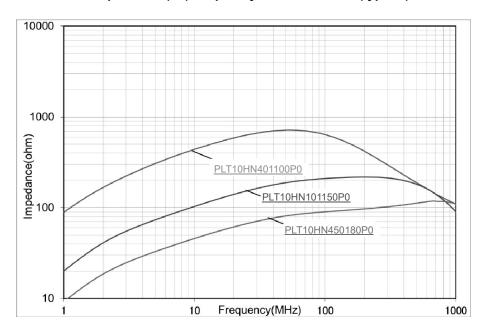
$$Rx = \frac{Gm - Go}{(Gm-Go)^2 + (Bm-Bo)^2} - Rs$$

$$Xx = \frac{-(Bm - Bo)}{(Gm-Go)^2 + (Bm-Bo)^2} - Xs$$

#### 12. P.C.B., Flux, Solder and Soldering condition

Test shall be done using P.C.B., Flux, Solder and Soldering condition which are specified in item 16 except the case of being specified special condition.

#### 13. Common Mode Impedance (Zc) frequency characteristics (typical)



### 14. Specification of Packaging 14.1 Packing Quantity

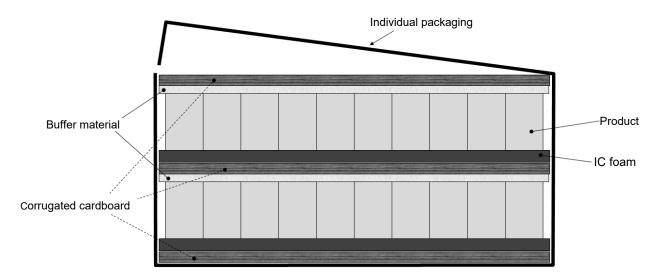
Individual packaging 100pcs

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#### 14.2. Packing Method

IC foam of the stuck products on are placed in an Individual packaging. A quantity in an Outer packaging is depending on a quantity of an order.



In some cases, omit the Buffer material and/or Currugated cardboard.

#### 14.3 Marking of packaging

#### (1) Individual packaing

The following items shall be marked on a label and the label is stuck on the Individual packaing. Customer part number, MURATA part number, Inspection number(\*1), RoHS discrimination (\*2), Quantity, etc

\*1) « Expression of Inspection No. »  $\square\square$  0000 ××× (1)

(1) Factory Code

(2) Date : Year / Last digit of year First digit

> Second digit : Month / Jan. to Sep. → 1 to 9, Oct. to Dec. → O,N,D

Third, Fourth digit: Day

(3) Serial No.

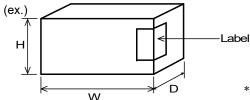
\*2) « Expression of RoHS discrimination »  $ROHS - \underline{Y}(\underline{\Delta})$ 

- (1) RoHS regulation conformity parts.
- (2) MURATA classification number

#### (2) Marking for Outside package

The following items shall be marked on a label and the label is stuck on the outside package. Customer name, Purchasing Order Number, Customer Part Number, MURATA part number, RoHS discrimination(\*2), Quantity, etc

#### 14.4 Specification of Outer Case



-			
Outer C	ase Dim	ensions	Standard Individual
	(mm)		package Quantity
W	D	Н	in Outer Case
265	89	118	5

\*Above Outer Case size is typical. It depends on a quantity of an order.

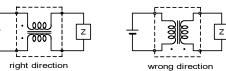
#### 15<u></u> Caution

#### **15.1 Mounting Direction**

Mount products in right direction.

Wrong direction which is 90° rotated from right direction causes not only open or short circuit but also flames or

other serious trouble.





#### 15.2 Fail Safe

Be sure to provide an appropriate fail-safe function on your product to prevent from a second damage that may be caused by the abnormal function or the failure of our products.

#### 15.3 Limitation of Applications

The products listed in the reference specification (hereinafter the product(s) is called as the "Product(s)") are designed and manufactured for applications specified in the reference specification (hereinafter called as the "Specific Application").

We shall not warrant anything in connection with the Products including fitness, performance, adequateness, safety, or quality, in the case of applications listed in from (1) to (11) written at the end of this precautions, which may generally require high performance, function, quality, management of production or safety. Therefore, the Product shall be applied in compliance with the specific application.

WE DISCLAIM ANY LOSS AND DAMAGES ARISING FROM OR IN CONNECTION WITH THE PRODUCTS INCLUDING BUT NOT LIMITED TO THE CASE SUCH LOSS AND DAMAGES CAUSED BY THE UNEXPECTED ACCIDENT, IN EVENT THAT (i) THE PRODUCT IS APPLIED FOR THE PURPOSE WHICH IS NOT SPECIFIED AS THE SPECIFIC APPLICATION FOR THE PRODUCT, AND/OR (ii) THE PRODUCT IS APPLIED FOR ANY FOLLOWING APPLICATION PURPOSES FROM (1) TO (11) (EXCEPT THAT SUCH APPLICATION PURPOSE IS UNAMBIGUOUSLY SPECIFIED AS SPECIFIC APPLICATION FOR THE PRODUCT IN OUR CATALOG SPECIFICATION FORMS, DATASHEETS, OR OTHER DOCUMENTS OFFICIALLY ISSUED BY US\*).

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Power plant control equipment
- (5) Medical equipment
- (6) Transportation equipment
- (7) Traffic control equipment
- (8) Disaster prevention/security equipment
- (9) Industrial data-processing equipment
- (10) Combustion/explosion control equipment
- (11) Equipment with complexity and/or required reliability equivalent to the applications listed in the above.

For exploring information of the Products which will be compatible with the particular purpose other than those specified in the reference specification, please contact our sales offices, distribution agents, or trading companies with which you make a deal, or via our web contact form.

Contact form: https://www.murata.com/contactform

\* We may design and manufacture particular Products for applications listed in (1) to (11). Provided that, in such case we shall unambiguously specify such Specific Application in the reference specification without any exception. Therefore, any other documents and/or performances, whether exist or non-exist, shall not be deemed as the evidence to imply that we accept the applications listed in (1) to (11).

#### 15.4 Attention regarding product's heat generation

Please pay special attention to the product's heat generation such as beyond Operating Temperature range, mounting product in close proximity to other products that radiate heat and beyond the rated current.

#### 15.5 Corrosive gas

Please refrain from use since contact with environments with corrosive gases (sulfur gas [hydrogen sulfide, sulfur dioxide, etc.], chlorine, ammonia, etc.) or oils (cutting oil, silicone oil, etc.) that have come into contact with the previously stated corrosive gas environment will result in deterioration of product quality or an open from deterioration due to corrosion of product electrode, etc. We will not bear any responsibility for use under these environments.

#### 16. Notice

Products can only be soldered with reflow.

This product is designed for solder mounting.

Please consult us in advance for applying other mounting method such as conductive adhesive.

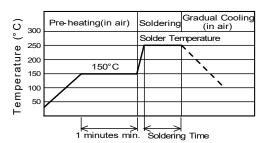
#### 16.1 Flux and Solder

Flux	Use rosin-based flux.Do not use highly acidic flux (with chlorine content exceeding0.2(wt)%) Do not use water soluble flux.	
Solder	Use Sn-3.0Ag-0.5Cu solder	

Other flux (except above) please contacts us for details, then use.

#### 16.2 Soldering

(1) Standard flow soldering profile.



Solder	Soldering
Temperature	Time
250 ~ 260 °C	4 ~ 6 s

- (2) Resistance to soldering iron goes in the following condition that tip temperature is 350  $^{\circ}$ C max. and soldering time is 5 s max.
- (3) Products and the leads should not be subjected to any mechanical stress during soldering process. (and also while subjected to the equivalent high temperature.)

#### (1)Solder paste printing for reflow soldering

· Standard thickness of solder paste should be 150 to 200 µm.

Incidentally, depending on the reflow condition and the way of heat conduction, the solder would not wet up the terminal, being possible to lead to not enough connection between terminals and lands on the circuit board / open circuit in the circuit board. In case of use, always evaluate this part in your products with actual use condition.

- · For the solder paste printing pattern, use standard land dimensions.
- · For the resist and copper foil pattern, use standard land dimensions.
- · Use Sn-3.0Ag-0.5Cu solder

#### 16.3 Cleaning Conditions

Products shall be cleaned on the following conditions.

- (1) Cleaning temperature shall be limited to 60 °C max. (40 °C max. for IPA.)
- (2) Ultrasonic cleaning shall comply with the following conditions, with avoiding the resonance phenomenon at the mounted products and P.C.B.

Power: 20W / I max. Frequency: 28kHz to 40kHz Time: 5 minutes max.

- (3) Cleaner
  - 1.Cleaner
    - · Isopropyl alcohol (IPA)
  - 2.Aqueous agent
    - · Higher Alcohol Type (PINE ALPHA ST-100S)
- (4) There shall be no residual flux and residual cleaner after cleaning.

In the case of using aqueous agent, products shall be dried completely after rinse with de-ionized water in order to remove the cleaner.

(5) The surface of products may become dirty whitely after cleaning.

But there is no deterioration on mechanical, electrical characteristics and reliability.

(6) Other cleaning

Please contact us.

#### 16.4 Operating Environment

Do not use this product under the following environmental conditions, on deterioration of the Insulation Resistance and/or corrosion of Inner Electrode may result from the use.

- (1) In the corrodible atmosphere (acidic gas, alkaline gas, chlorine, sulfur gas, organic gas and etc.)
- (2) In the atmosphere where liquid such as organic solvent, may splash on the products.
- (3) In the atmosphere where the temperature / humidity changes rapidly and it is easy to dew.
- (4) In the atmosphere where the product is covered with dust or is subjected to salty breeze.

#### 16.5 Storage Conditions

(1)Storage period

Use the products within 12 months after delivered.

Solderability should be checked if this period is exceeded.

(2)Storage conditions

• Products should be stored in the warehouse on the following conditions.

Temperature: -10°C to 40°C

Humidity: 15% to 85% relative humidity

No rapid change on temperature and humidity

- Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.
- Products should be stored in the warehouse without heat shock, vibration, direct sunlight and so on.
- Avoid storing the product by itself bare (i.e.exposed directly to air).

(3)Delivery

Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

#### 17. A Note

- (1)Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2)You are requested not to use our product deviating from the reference specifications.
- (3)The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.